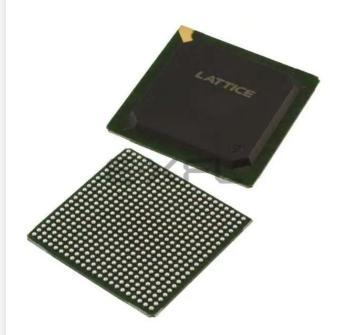
## Lattice Semiconductor Corporation - LFEC15E-3F484I Datasheet



Welcome to **E-XFL.COM** 

# Understanding <u>Embedded - FPGAs (Field Programmable Gate Array)</u>

Embedded - FPGAs, or Field Programmable Gate Arrays, are advanced integrated circuits that offer unparalleled flexibility and performance for digital systems. Unlike traditional fixed-function logic devices, FPGAs can be programmed and reprogrammed to execute a wide array of logical operations, enabling customized functionality tailored to specific applications. This reprogrammability allows developers to iterate designs quickly and implement complex functions without the need for custom hardware.

#### **Applications of Embedded - FPGAs**

The versatility of Embedded - FPGAs makes them indispensable in numerous fields. In telecommunications.

Details	
Product Status	Obsolete
Number of LABs/CLBs	-
Number of Logic Elements/Cells	15400
Total RAM Bits	358400
Number of I/O	352
Number of Gates	-
Voltage - Supply	1.14V ~ 1.26V
Mounting Type	Surface Mount
Operating Temperature	-40°C ~ 100°C (TJ)
Package / Case	484-BBGA
Supplier Device Package	484-FPBGA (23x23)
Purchase URL	https://www.e-xfl.com/product-detail/lattice-semiconductor/lfec15e-3f484i

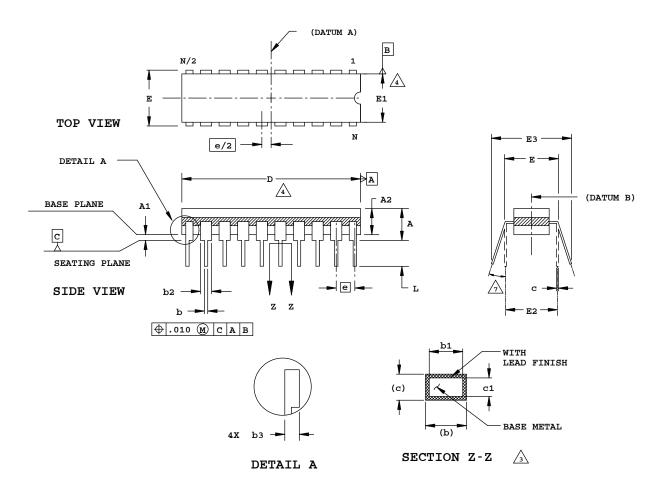
Email: info@E-XFL.COM

Address: Room A, 16/F, Full Win Commercial Centre, 573 Nathan Road, Mongkok, Hong Kong



# 20-Pin (300-Mil) CERDIP Package

#### Dimensions in Inches



#### NOTES:

- DIMENSIONING AND TOLERANCING PER ANSI Y14.5M.
- 2. ALL DIMENSIONS ARE IN INCHES.



MEASUREMENTS TO BE TAKEN AT A MINIMUM OF .060 INCHES FROM THE LEAD TIP.



DIMENSIONS D AND E1 INCLUDE ALLOWANCE FOR GLASS OVERRUN AND MENISCUS, AND LID TO BASE MISMATCH.

- 5. DIMENSIONS A, A1 AND L ARE MEASURED WITH THE PACKAGE SEATED IN JEDEC SEATING PLANE GAUGE GS-003.
- 6. E3 IS TO BE MEASURED AT THE LEAD TIPS.



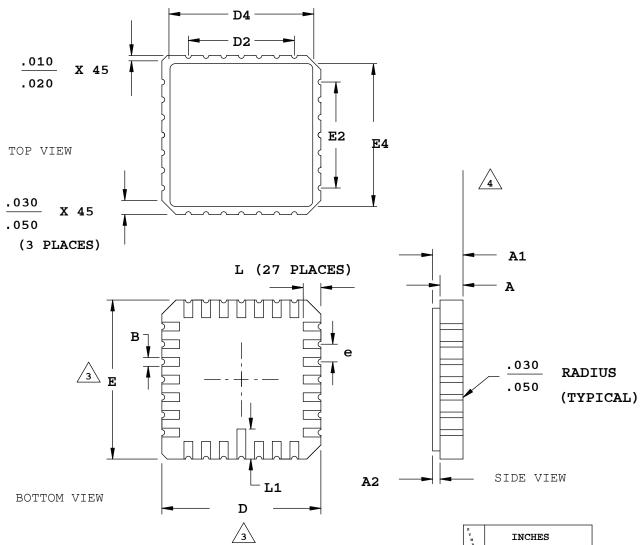
ALLOWED LEAD TIP POSITION RANGE.

s Y M B	INCHES			
O L	MIN.	NOM.	MAX.	
A	-	-	.200	
A1	.015	-	-	
A2	.140	-	.175	
b	.015	-	.023	
b1	.015	.018	.021	
b2	.045	-	.065	
b3	.023	-	.045	
С	.008	-	.014	
с1	.008	.010	.012	
D	.942	.950	.970	
E	.308	-	.325	
E1	.280	.288	.296	
E2	. 3	.300 REF		
E3	.325	-	.410	
е	.100 BSC			
L	.125	-	.200	
N	20			



# 28-Pin LCC Package

Dimensions in Inches



#### NOTES:

- 1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5.
- 2. ALL DIMENSIONS ARE IN INCHES.

<u>/3.</u>

DIMENSIONS D AND E MAY HAVE MATERIAL PROTRUSION OF .010 INCHES MAXIMUM ABOVE THE DIMENSION SHOWN NOT TO EXCEED .005 INCHES MAXIMUM PER SIDE.



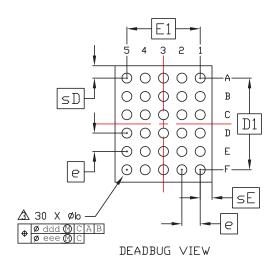
FLATNESS TOLERANCE IS .004 INCHES PER INCH.

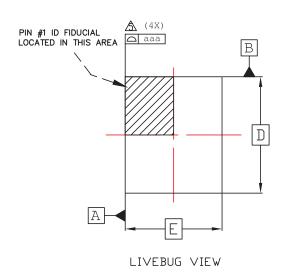
S Y M	INCHES		
0 L	MIN.		MAX.
A	.054		.074
A1	.064		.089
<b>A</b> 2	.007		.015
В	.022		.028
D	.440		.460
D2		.300	
D4	.370		.403
E	.440		.460
E2		.300	
E4	.370		.403
е	.050 BSC		
L	.042		.058
L1	.075		.095

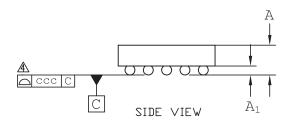


## 30-Ball WLSC Package

#### **Dimensions in Millimeters**







#### Notes:

- 1 ALL DIMENSIONS AND TOLERANCE PER ASME Y 14.5M 1994. 2 ALL DIMENSIONS ARE IN MILLIMETERS.
- △ DIMENSION "6" IS MEASURED AT THE MAXIMUM BUMP DIAMETER PARALLEL TO PRIMARY DATUM C.
- A PRIMARY DATUM C AND SEATING PLANE ARE DEFINED BY THE SPHERICAL CROWNS OF THE SOLDER BUMPS.

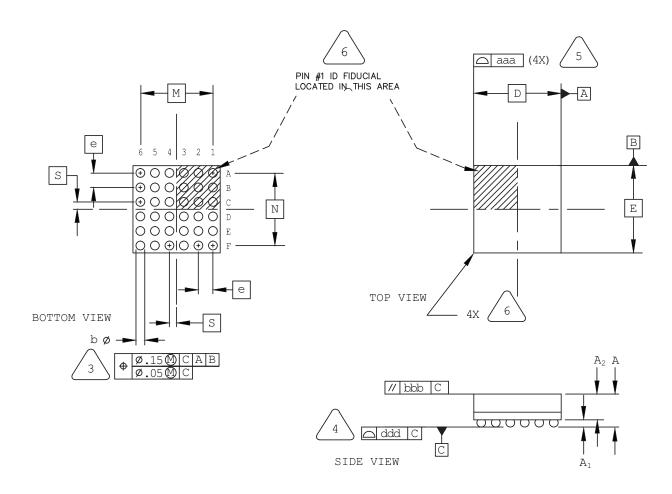
  A BILATERAL TOLERANCE ZONE IS APPLIED TO EACH SIDE OF THE
- PACKAGE BODY.

REF.	Min.	Nom.	Max.
Α	_	ı	0.600
A1	0.140	ı	-
b	0.230	0.260	0.290
D	2.5	537 BSC	)
Е	2	.114 BSC	,
D1	i	2.00 BSC	)
E1	1.60 BSC		
е	0.40 BSC		
sD	_	0.26	_
sE	_	0.27	_
۵۵۵	0.030		
CCC	0.050		
ddd	0.015		
666		0.050	



## 36-Ball ucfBGA Package: iCE40 Ultra™

#### **Dimensions in Millimeters**



NOTES: UNLESS OTHERWISE SPECIFIED

1. DIMENSIONS AND TOLERANCES PER ANSI Y14.5M.

2. ALL DIMENSIONS ARE IN MILLIMETERS.

3

DIMENSION "b" IS MEASURED AT THE MAXIMUM SOLDER BALL DIAMETER, PARALLEL TO PRIMARY DATUM C



PRIMARY DATUM C AND SEATING
PLANE ARE DEFINED BY THE SPHERICAL
CROWNS OF THE SOLDER BALLS.



BILATERAL TOLERANCE ZONE IS APPLIED TO EACH SIDE OF THE PACKAGE BODY.

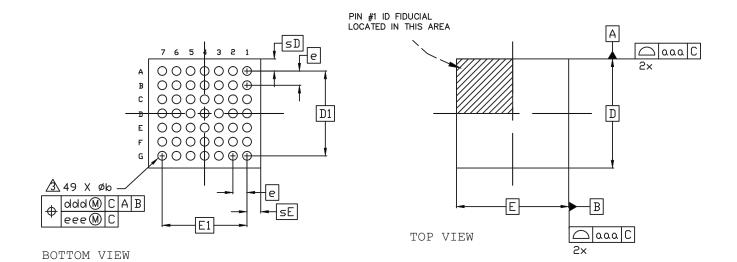


SYMBOL	MIN.	NOM.	MAX.
А	ı	0.81	0.91
A1	0.12	_	-
A2	_	_	0.70
D/E	2.50 BSC		
M/N	2.00 BSC		
S	0.20 BSC		
b	0.20	0.25	0.30
е	0.40 BSC		
aaa	_	_	0.10
bbb	_	_	0.10
ddd	_	_	0.10



## 49-Ball WLCS Package

#### **Dimensions in Millimeters**



M bbb C A A

SIDE VIEW

#### Notes:

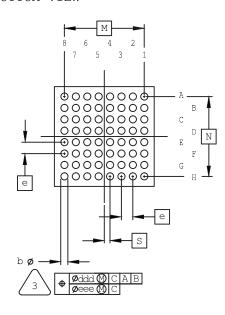
- 1 ALL DIMENSIONS AND TOLERANCE PER ASME Y 14.5M 1994.
- 2 ALL DIMENSIONS ARE IN MILLIMETERS.
- △ DIMENSION "b" IS MEASURED AT THE MAXIMUM BUMP DIAMETER PARALLEL TO PRIMARY DATUM C.
- riangle PRIMARY DATUM C AND SEATING PLANE ARE DEFINED BY THE SPHERICAL CROWNS OF THE SOLDER BUMPS.

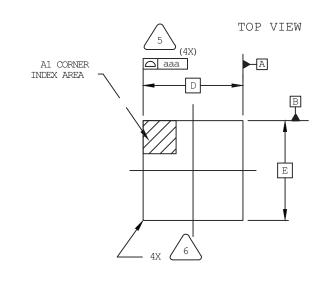
REF.	Min.	Nom.	Max.
A	_		0.600
A1	0.167	0.199	0.232
b	0.239	0.266	0.319
D	3.055	3.106	3.155
E	3.125	3.185	3.225
D1	2.40 BSC		
E1	2	.40 BSC	
е	0	.40 BSC	
sD	0.353	_	0.383
sE	0.388	-	0.418
aaa	(	0.030	
bbb	0.060		
ccc	0.050		
ddd	0.015		
eee	(	0.050	
	•		

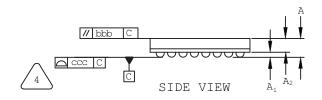


#### **Dimensions in Millimeters**

#### BOTTOM VIEW







NOTES: UNLESS OTHERWISE SPECIFIED

- 1. DIMENSIONS AND TOLERANCES PER ANSI Y14.5M.
- 2. ALL DIMENSIONS ARE IN MILLIMETERS.



DIMENSION "b" IS MEASURED AT THE MAXIMUM SOLDER BALL DIAMETER, PARALLEL TO PRIMARY DATUM [C].



PRIMARY DATUM [C] AND SEATING PLANE ARE DEFINED BY THE SPHERICAL CROWNS OF THE SOLDER BALLS.



BILATERAL TOLERANCE ZONE IS APPLIED TO EACH SIDE OF THE PACKAGE BODY.



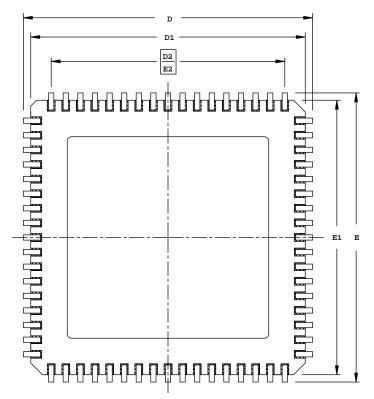
SYMBOL	MIN.	NOM.	MAX.
А	-	_	1.00
A1	0.11	_	-
A2	0.62	-	_
D/E		3.50 BSC	
M/N		2.80 BSC	
S		0.20 BSC	
b	0.20	0.25	0.30
е	0.40 BSC		
aaa	0.10		
bbb	0.10		
ccc	0.08		
ddd	0.15		
eee		0.08	

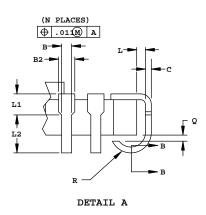


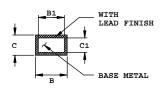
# 68-Pin JLCC Package

#### Dimensions in Inches

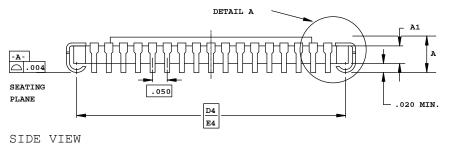
#### BOTTOM VIEW







SECTION B-B



#### NOTES:

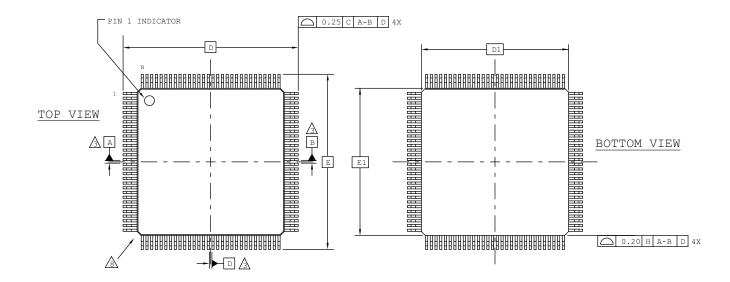
- 1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M.
- 2. ALL DIMENSIONS ARE IN INCHES.
- 3. CORNER CHAMFERS AND/OR NOTCHES ARE OPTIONAL.

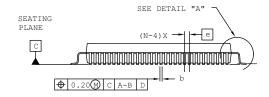
S M B O L	INCHES		
o r	MIN.		MAX.
A	.115	ı	.190
A1	. (	80 RE	F
В	.013	-	.023
B1	.013	-	.020
B2	.022	-	.035
С	.007	-	.013
C1	.007	-	.010
D/E	.975	.990	1.000
D1/E1	.920	1	.960
D2/E2	. 8	00 BS	С
D4/E4	. 9	30 BS	C
L	.005	-	ı
L1	.020	-	-
L2	.025	-	-
Q	.003	1	-
R	.020	•	.040
N		68	

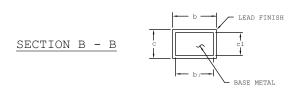


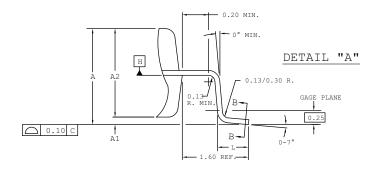
## 128-Pin PQFP Package

#### **Dimensions in Millimeters**









#### NOTES:

- 1.0 DIMENSIONING AND TOLERANCING PER ANSI Y14.5 1982.
- 2.0 ALL DIMENSIONS ARE IN MILLIMETERS.
- A DATUMS A, B AND D TO BE DETERMINED AT DATUM PLANE H.
- 4.0 DIMENSIONS D1 AND E1 D0 NOT INCLUDE MOLD PROTRUSION.

  ALLOWABLE MOLD PROTRUSION IS 0.254 MM ON D1 AND E1 DIMENSIONS.
- 5.0 THE TOP OF PACKAGE MAY BE SMALLER THAN THE BOTTOM OF THE PACKAGE BY 0.15 MM.
- 6.0 SECTION B-B:
  THESE DIMENSIONS APPLY TO THE FLAT SECTION OF THE
  LEAD BETWEEN 0.10 AND 0.25 MM FROM THE LEAD TIP.
- 7.0 A1 IS DEFINED AS THE DISTANCE FROM THE SEATING PLANE TO THE LOWEST POINT ON THE PACKAGE BODY.

& EXACT SHAPE OF EACH CORNER IS OPTIONAL.

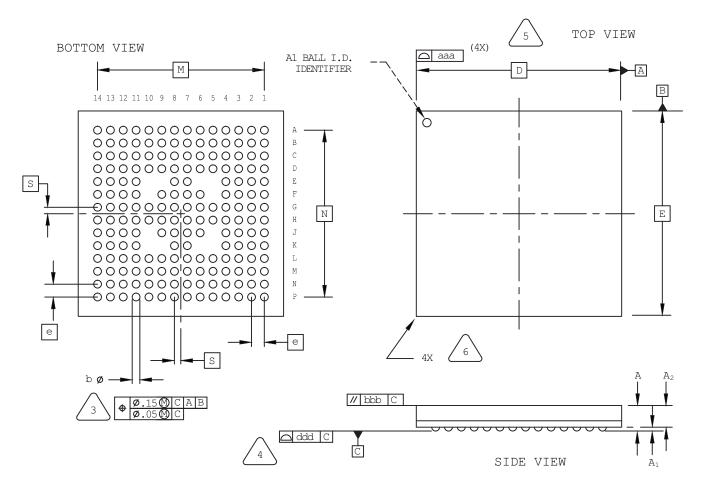
♠ EXACT SHAPE OF EXPOSED HEATSINK IS OPTIONAL.

SYMBOL	MIN.	NOM.	MAX.
A	-	-	4.10
A1	0.25	-	0.50
A2	3.20	3.40	3.60
D		31.20 BSC	!
D1		28.00 BSC	
E		31.20 BSC	!
E1	28.00 BSC		
L	0.73	0.88	1.03
N		128	
е		0.80 BSC	
b	0.29	-	0.45
b1	0.29	0.35	0.41
С	0.11	-	0.23
с1	0.11	0.15	0.19



### 184-Ball csBGA Package

#### **Dimensions in Millimeters**



NOTES: UNLESS OTHERWISE SPECIFIED

- 1. DIMENSIONS AND TOLERANCES PER ANSI Y14.5M.
- 2. ALL DIMENSIONS ARE IN MILLIMETERS.



DIMENSION "b" IS MEASURED AT THE MAXIMUM SOLDER BALL DIAMETER, PARALLEL TO PRIMARY DATUM C



PRIMARY DATUM C AND SEATING PLANE ARE DEFINED BY THE SPHERICAL CROWNS OF THE SOLDER BALLS.



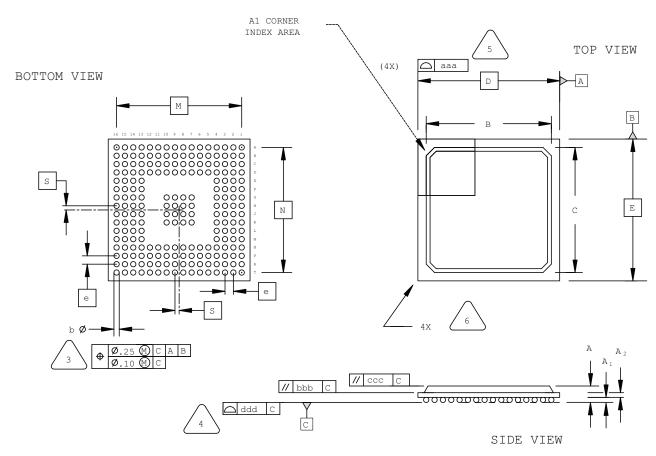
BILATERAL TOLERANCE ZONE IS APPLIED TO EACH SIDE OF THE PACKAGE BODY.



SYMBOL	MIN.	NOM.	MAX.
А	1.20	1.35	1.50
A1	0.16	_	-
A2	_	_	1.34
D/E	8.00 BSC		
M/N	6.50 BSC		
S	0.25 BSC		
b	0.25	0.30	0.35
е	0.50 BSC		
aaa	0.10		
bbb	_	_	0.10
ddd	-	_	0.08



#### **Dimensions in Millimeters**



NOTES: UNLESS OTHERWISE SPECIFIED

- DIMENSIONS AND TOLERANCES PER ANSI Y14.5M.
- 2. ALL DIMENSIONS ARE IN MILLIMETERS.



DIMENSION "b" IS MEASURED AT THE MAXIMUM SOLDER BALL DIAMETER, PARALLEL TO PRIMARY DATUM C



PRIMARY DATUM C AND SEATING PLANE ARE DEFINED BY THE SPHERICAL CROWNS OF THE SOLDER BALLS.



BILATERAL TOLERANCE ZONE IS APPLIED TO EACH SIDE OF THE PACKAGE BODY.

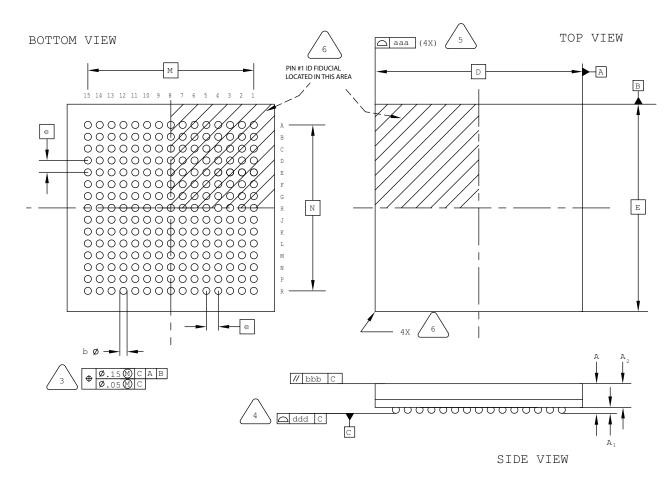


	ı	I	
SYMBOL	MIN.	NOM.	MAX.
А	1.30	1.70	2.10
A1	0.30	0.50	0.70
A2	0.30	0.50	0.70
B/C	14.80	15.30	15.80
D/E	1	7.00 BSC	
M/N	15.00 BSC		
S		0.50 BSC	
b	0.50	0.60	0.70
е	1.00 BSC		
aaa	_	_	0.20
bbb			0.25
ccc	_		0.35
ddd	_	_	0.20



# 225-Ball ucBGA Package

#### **Dimensions in Millimeters**



NOTES: UNLESS OTHERWISE SPECIFIED

- 1. DIMENSIONS AND TOLERANCES PER ANSI Y14.5M.
- 2. ALL DIMENSIONS ARE IN MILLIMETERS.



DIMENSION "b" IS MEASURED AT THE MAXIMUM SOLDER BALL DIAMETER, PARALLEL TO PRIMARY DATUM [C]



PRIMARY DATUM C AND SEATING PLANE ARE DEFINED BY THE SPHERICAL CROWNS OF THE SOLDER BALLS.



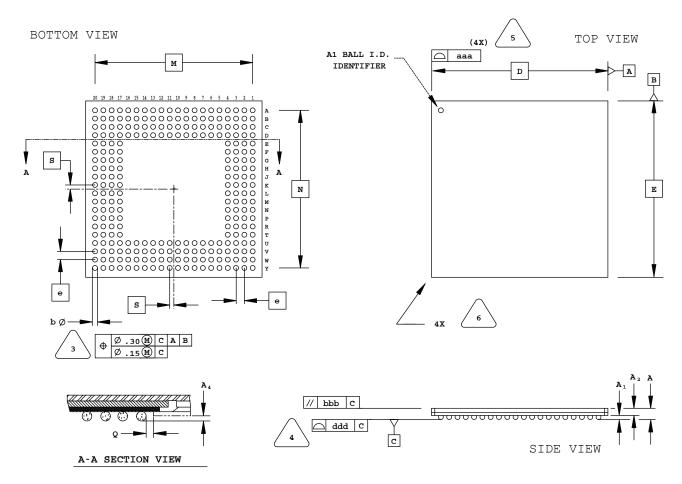
BILATERAL TOLERANCE ZONE IS APPLIED TO EACH SIDE OF THE PACKAGE BODY.



SYMBOL	MIN.	NOM.	MAX.
А	ı	-	1.00
A1	0.10	_	_
A2	ı	-	0.90
D/E	7.00 BSC		
M/N	5.60 BSC		
b	0.20	0.25	0.30
е	0	.40 BSC	
aaa	-	-	0.10
bbb	-	_	0.10
ddd	_	_	0.10



#### **Dimensions in Millimeters**



NOTES: UNLESS OTHERWISE SPECIFIED

- 1. DIMENSIONS AND TOLERANCES PER ANSI Y14.5M.
- 2. ALL DIMENSIONS ARE IN MILLIMETERS.



DIMENSION "b" IS MEASURED AT THE MAXIMUM SOLDER BALL DIAMETER, PARALLEL TO PRIMARY DATUM C



PRIMARY DATUM C AND SEATING PLANE ARE DEFINED BY THE SPHERICAL CROWNS OF THE SOLDER BALLS.



BILATERAL TOLERANCE ZONE IS APPLIED TO EACH SIDE OF THE PACKAGE BODY.

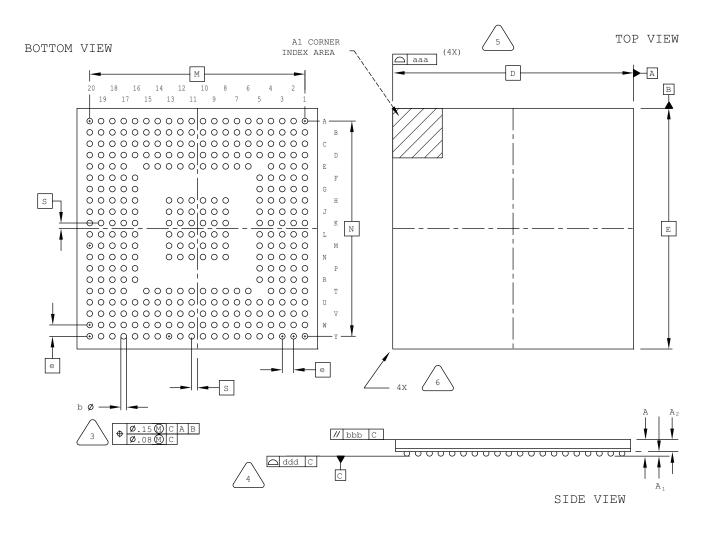


		<u> </u>	
SYMBOL	MIN.	NOM.	MAX.
A	-	-	1.70
A1	0.50	0.65	0.80
A2	0.80	0.90	1.00
D/E	27	7.00 BSC	
M/N	24.13 BSC		
s	0.635 BSC		
b	0.60	0.75	0.90
е	1.27 BSC		
Q	0.25	-	-
A4	0.10	-	-
aaa	-	-	0.20
bbb	-	-	0.25
ddd	-	-	0.20



### 332-Ball caBGA Package

#### **Dimensions in Millimeters**



NOTES: UNLESS OTHERWISE SPECIFIED

- 1. DIMENSIONS AND TOLERANCES PER ANSI Y14.5M.
- 2. ALL DIMENSIONS ARE IN MILLIMETERS.



DIMENSION "b" IS MEASURED AT THE MAXIMUM SOLDER BALL DIAMETER, PARALLEL TO PRIMARY DATUM C



PRIMARY DATUM C AND SEATING
PLANE ARE DEFINED BY THE SPHERICAL
CROWNS OF THE SOLDER BALLS.



BILATERAL TOLERANCE ZONE IS APPLIED TO EACH SIDE OF THE PACKAGE BODY.

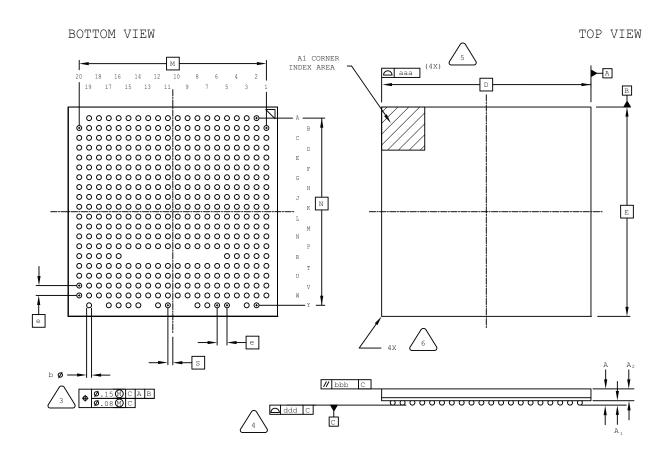


SYMBOL	MIN.	NOM.	MAX.
А	-	-	2.00
A1	0.25	_	_
A2	0.65	_	_
D/E	17.0 BSC		
M/N	15.2 BSC		
S	0.40 BSC		
b	0.40	0.45	0.50
е	0.80 BSC		
aaa	-	-	0.15
bbb	_	-	0.20
ddd	_	-	0.20



### 381-Ball caBGA Package

#### **Dimensions in Millimeters**



NOTES: UNLESS OTHERWISE SPECIFIED

- DIMENSIONS AND TOLERANCES PER ANSI Y14.5M.
- 2. ALL DIMENSIONS ARE IN MILLIMETERS.



DIMENSION "b" IS MEASURED AT THE MAXIMUM SOLDER BALL DIAMETER, PARALLEL TO PRIMARY DATUM C



PRIMARY DATUM C AND SEATING PLANE ARE DEFINED BY THE SPHERICAL CROWNS OF THE SOLDER BALLS.



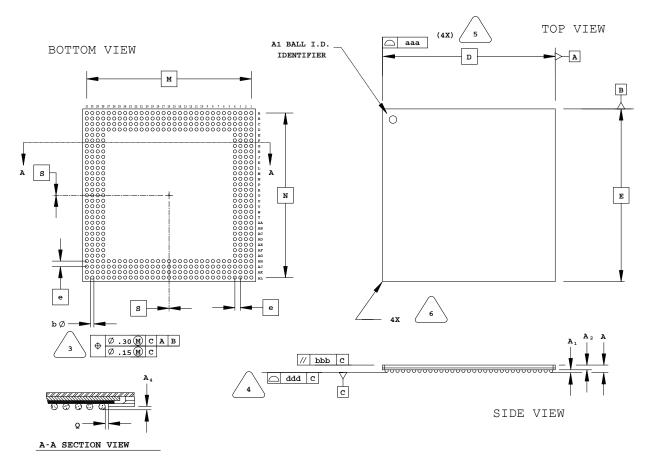
BILATERAL TOLERANCE ZONE IS APPLIED TO EACH SIDE OF THE PACKAGE BODY.



SYMBOL	MIN.	NOM.	MAX.
А	ı	-	1.76
A1	0.25	0.30	0.35
A2	0.80	-	ı
D/E	17.00 BSC		
M/N	15.20 BSC		
S	0.40 BSC		
b	0.35	0.40	0.45
е	0.80 BSC		
aaa	_	-	0.15
bbb	-	-	0.20
ddd	-	_	0.12



#### **Dimensions in Millimeters**



NOTES: UNLESS OTHERWISE SPECIFIED

- DIMENSIONS AND TOLERANCES PER ANSI Y14.5M.
- 2. ALL DIMENSIONS ARE IN MILLIMETERS.



DIMENSION "b" IS MEASURED AT THE MAXIMUM SOLDER BALL DIAMETER, PARALLEL TO PRIMARY DATUM C



PRIMARY DATUM C AND SEATING
PLANE ARE DEFINED BY THE SPHERICAL
CROWNS OF THE SOLDER BALLS.



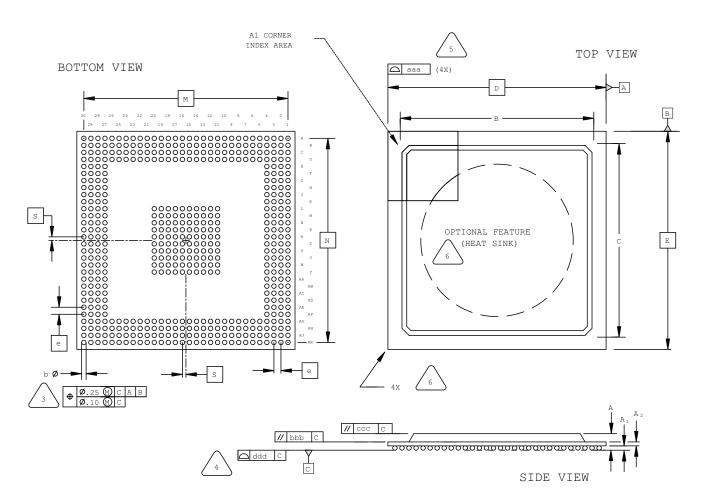
BILATERAL TOLERANCE ZONE IS APPLIED TO EACH SIDE OF THE PACKAGE BODY.



MIN. - ).50	NOM.	MAX. 1.70
-	-	1.70
.50	0.65	
	0.65	0.80
0.80	0.90	1.00
4.0	0.00 BSC	<b>.</b>
38.10 BSC		
0.00 BSC		
.60	0.75	0.90
1.27 BSC		
.25	-	-
.10	-	-
-	-	0.20
-	-	0.25
-	-	0.20
	38	0.00 BSC 0.60 0.75 1.27 BSC



#### **Dimensions in Millimeters**



NOTES: UNLESS OTHERWISE SPECIFIED

1. DIMENSIONS AND TOLERANCES PER ANSI Y14.5M.

2. ALL DIMENSIONS ARE IN MILLIMETERS.



DIMENSION "b" IS MEASURED AT THE MAXIMUM SOLDER BALL DIAMETER, PARALLEL TO PRIMARY DATUM C



PRIMARY DATUM C AND SEATING PLANE ARE DEFINED BY THE SPHERICAL CROWNS OF THE SOLDER BALLS.



BILATERAL TOLERANCE ZONE IS APPLIED TO EACH SIDE OF THE PACKAGE BODY.

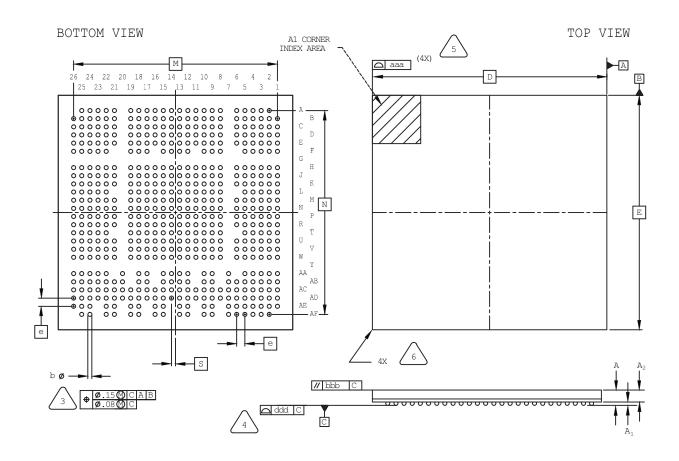


SYMBOL	MIN.	NOM.	MAX.
А	1.70	2.15	2.60
A1	0.30	0.50	0.70
A2	0.30	0.50	0.70
B/C	25.80	27.55	29.30
D/E	31.00 BSC		
M/N	29.00 BSC		
S	0.50 BSC		
b	0.50	0.60	0.70
е	1.00 BSC		
aaa	-	-	0.20
bbb	-	-	0.25
ccc	-	-	0.35
ddd	-	-	0.20



### 554-Ball caBGA Package

#### **Dimensions in Millimeters**



NOTES: UNLESS OTHERWISE SPECIFIED

1. DIMENSIONS AND TOLERANCES PER ANSI Y14.5M.

2. ALL DIMENSIONS ARE IN MILLIMETERS.

 $\sqrt{3}$ 

DIMENSION "b" IS MEASURED AT THE MAXIMUM SOLDER BALL DIAMETER, PARALLEL TO PRIMARY DATUM  $\boxed{\mathbb{C}}$ 



PRIMARY DATUM [C] AND SEATING PLANE ARE DEFINED BY THE SPHERICAL CROWNS OF THE SOLDER BALLS.



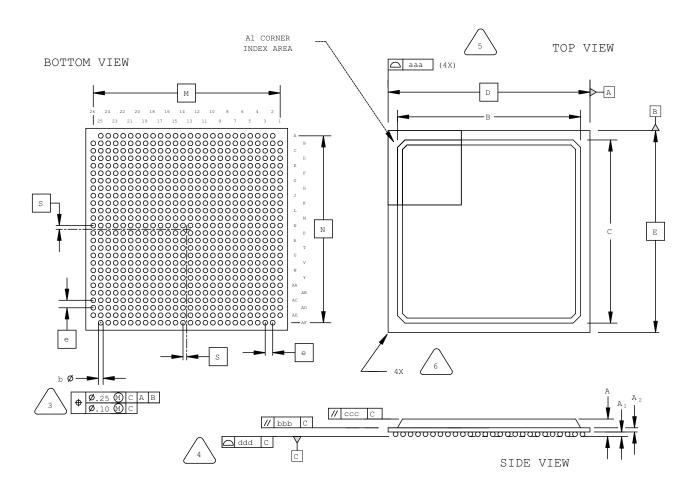
BILATERAL TOLERANCE ZONE IS APPLIED TO EACH SIDE OF THE PACKAGE BODY.



SYMBOL	MIN.	NOM.	MAX.
А	-	-	1.76
A1	0.25	0.30	0.35
A2	0.80	-	-
D/E	23.0 BSC		
M/N	20.0 BSC		
S	0.40 BSC		
b	0.35	0.40	0.45
е	0.80 BSC		
aaa	_	_	0.15
bbb	_	_	0.20
ddd	_	_	0.12



#### **Dimensions in Millimeters**



NOTES: UNLESS OTHERWISE SPECIFIED

- 1. DIMENSIONS AND TOLERANCES PER ANSI Y14.5M.
- 2. ALL DIMENSIONS ARE IN MILLIMETERS.



DIMENSION "b" IS MEASURED AT THE MAXIMUM SOLDER BALL DIAMETER, PARALLEL TO PRIMARY DATUM C



PRIMARY DATUM C AND SEATING PLANE ARE DEFINED BY THE SPHERICAL CROWNS OF THE SOLDER BALLS.



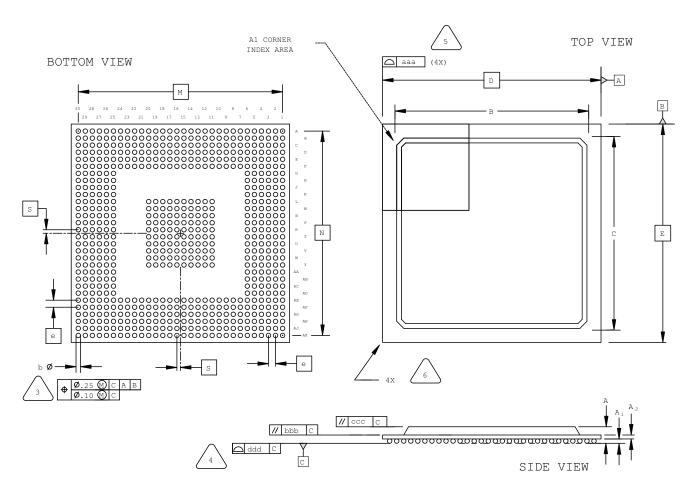
BILATERAL TOLERANCE ZONE IS APPLIED TO EACH SIDE OF THE PACKAGE BODY.



SYMBOL	MIN.	NOM.	MAX.
А	1.70	2.15	2.60
A1	0.30	0.50	0.70
A2	0.30	0.50	0.70
B/C	23.80	24.80	25.80
D/E	27.00 BSC		
M/N	25.00 BSC		
S	0.50 BSC		
b	0.50	0.60	0.70
е	1.00 BSC		
aaa	-	-	0.20
bbb	-	_	0.25
ccc	-	-	0.35
ddd	_	_	0.20



#### **Dimensions in Millimeters**



NOTES: UNLESS OTHERWISE SPECIFIED

 DIMENSIONS AND TOLERANCES PER ANSI Y14.5M.

2. ALL DIMENSIONS ARE IN MILLIMETERS.



DIMENSION "b" IS MEASURED AT THE MAXIMUM SOLDER BALL DIAMETER, PARALLEL TO PRIMARY DATUM C



PRIMARY DATUM C AND SEATING PLANE ARE DEFINED BY THE SPHERICAL CROWNS OF THE SOLDER BALLS.



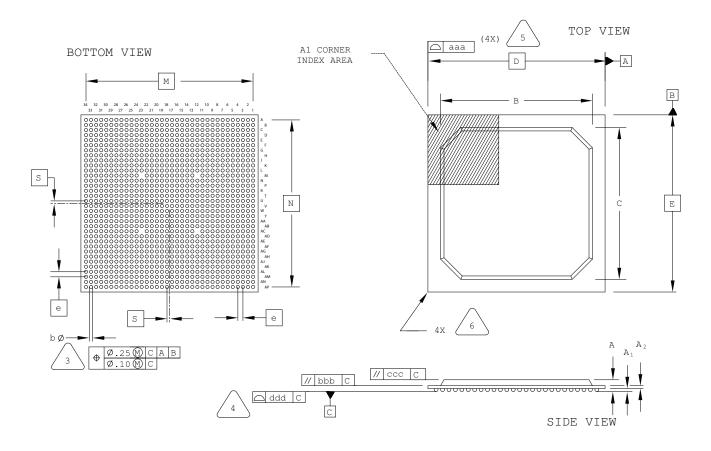
BILATERAL TOLERANCE ZONE IS APPLIED TO EACH SIDE OF THE PACKAGE BODY.



SYMBOL	MIN.	NOM.	MAX.
А	1.70	2.15	2.60
A1	0.30	0.50	0.70
A2	0.30	0.50	0.70
B/C	25.80	27.55	29.30
D/E	31.00 BSC		
M/N	29.00 BSC		
S	0.50 BSC		
b	0.50	0.60	0.70
е	1.00 BSC		
aaa	-	-	0.20
bbb	-	-	0.25
ccc	-	-	0.35
ddd	-	-	0.20



#### **Dimensions in Millimeters**



NOTES: UNLESS OTHERWISE SPECIFIED

- 1. DIMENSIONS AND TOLERANCES PER ANSI Y14.5M.
- 2. ALL DIMENSIONS ARE IN MILLIMETERS.



DIMENSION "b" IS MEASURED AT THE MAXIMUM SOLDER BALL DIAMETER, PARALLEL TO PRIMARY DATUM [C]



PRIMARY DATUM C AND SEATING PLANE ARE DEFINED BY THE SPHERICAL CROWNS OF THE SOLDER BALLS.



BILATERAL TOLERANCE ZONE IS APPLIED TO EACH SIDE OF THE PACKAGE BODY.



EXACT SHAPE AND SIZE OF THIS FEATURE IS OPTIONAL.

Note: Depopulated ball locations are M12, M23, AC12, and AC23.

SYMBOL	MIN.	NOM.	MAX.
А	1.90	2.25	2.60
A1	0.30	0.50	0.70
A2	0.40	0.60	0.80
B/C	29.80	30.30	30.80
D/E	35.00 BSC		
M/N	33.00 BSC		
S	0.50 BSC		
b	0.50	0.60	0.70
е	1.00 BSC		
aaa	_	_	0.20
bbb	_	_	0.25
ccc	-	-	0.35
ddd	_	_	0.20